

ZXTP03200BG 200V PNP Low V_{CE}(sat) transistor in SOT223

Summary

$$\begin{split} & {\sf BV}_{{\sf CEO}} > -200V \\ & {\sf BV}_{{\sf ECO}} > -2V \\ & {\sf I}_{{\sf C}({\sf cont})} = 2A \\ & {\sf V}_{{\sf CE}({\sf sat})} < -160mV @ -1A \\ & {\sf R}_{{\sf CE}({\sf sat})} = 135m\Omega \\ & {\sf P}_{{\sf D}} = 3W \end{split}$$



ZETEX

Description

Packaged in the SOT223 outline this new 5th generation low saturation 200V PNP transistor offers extremely low on state losses making it ideal for use in DC-DC circuits and various driving and power management functions

Features

- 2 Amps continuous current
- Up to 5 Amps peak current
- Very low saturation voltage
- · Enhanced switching performance

Applications

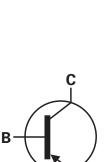
DC-DC conversion

Ordering Information

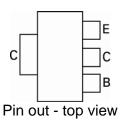
Device	Reel size	Tape width	Quantity	
	(inches)	(mm)	per reel	
ZXTP03200BGTA	7	12	1000	

Device Marking

ZXTP03200BG



F



Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V _{CBO}	-220	V
Collector-Emitter Voltage	V _{CEO}	-200	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current ^(a)	Ι _C	-2	А
Base Current	Ι _Β	-1	А
Peak Pulse Current	I _{CM}	-5	А
Power Dissipation at T _A =25°C ^(a) Linear Derating Factor	PD	1.25 10	W mW/°C
Power Dissipation at T _A =25°C ^(b) Linear Derating Factor	PD	1.65 13.2	W mW/°C
Power Dissipation at T _A =25°C ^(C) Linear Derating Factor	PD	3 24	W mW/°C
Power Dissipation at T _A =25°C ^(d) Linear Derating Factor	PD	5.8 46.5	W mW/°C
Power Dissipation at T _c =25°C ^(e) Linear Derating Factor	PD	11.9 95.2	W mW/°C
Operating and Storage Temperature Range	Tj, T _{stg}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit	
Junction to Ambient ^(a)	$R_{ heta JA}$	100	°C/W	
Junction to Ambient ^(b)	$R_{ ext{ heta}JA}$	76	°C/W	
Junction to Ambient (C)	R _{0JA}	41.6	°C/W	
Junction to Ambient ^(d)	$R_{ ext{ heta}JA}$	21.5	°C/W	
Junction to Lead ^(e)	R _{θJL}	10.5	°C/W	

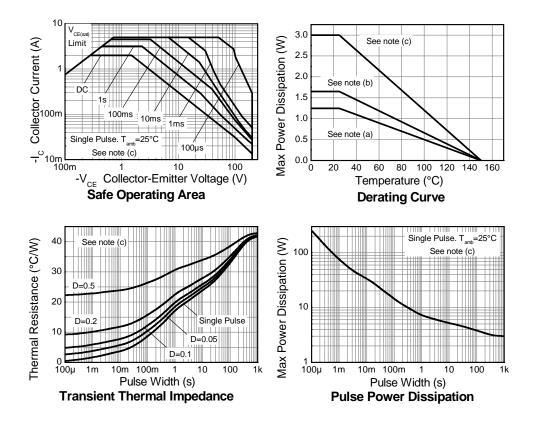
NOTES:

(a) For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) Mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
(c) Mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
(d) As (c) above measured at t<5 seconds.

(e) Junction to Lead from Collector Tab. Typical

Thermal Characteristics



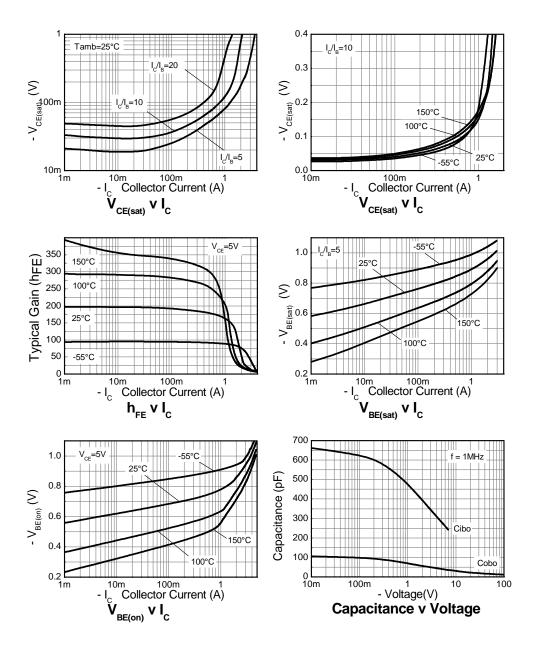
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-Base Breakdown Voltage	BV _{CBO}	-220	-245		V	I _C = -100μA
Collector-Emitter Breakdown Voltage	BV _{CER}	-220	-245		V	$I_{\rm C}$ = -1µA, R _{BE} ≤ 1kΩ
Collector-Emitter Breakdown voltage	BV _{CEO}	-200	-225		V	I _C = -10mA ^(*)
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.4		V	I _E = -100μA
Collector-Base Cut-off	I _{CBO}		<1	-50	nA	V _{CB} = -200V
Current				-0.5	μA	V _{CB} = -200V,T _{amb} =100°C
Emitter Cut-off Current	I _{EBO}		<1	-10	nA	V _{EB} = -6V
Collector-Emitter Saturation	V _{CE(sat)}		-37	-50	mV	$I_{C} = -0.1A, I_{B} = -10mA^{(*)}$
Voltage			-130	-155	mV	$I_{C} = -0.5A, I_{B} = -25mA_{(*)}^{(*)}$
			-135	-160	mV	$I_{C} = -1A, I_{B} = -100 \text{mA}^{(*)}$
			-180	-275	mV	$I_{C} = -2A, I_{B} = -400 \text{mA}^{(*)}$
Base-Emitter Saturation Voltage	V _{BE(sat)}		-955	-1100	mV	$I_{\rm C}$ = -2A, $I_{\rm B}$ = -400mA ^(*)
Base-Emitter Turn-On Voltage	V _{BE(on)}		-860	-1000	mV	$I_{C} = -2A, V_{CE} = -5V^{(*)}$
Static Forward Current	h _{FE}	100	195			$I_{C} = -10 \text{mA}, V_{CE} = -5 V^{(*)}$
Transfer Ratio		100	170	300		$I_{C} = -1A, V_{CE} = -5V_{(*)}^{(*)}$
		20	50			$I_{C} = -2A, V_{CE} = -5V^{(*)}$
			5			$I_{C} = -5A, V_{CE} = -5V^{(*)}$
Transition Frequency	f _T		105		MHz	I _C = -100mA, V _{CE} = -10V f = 50MHz
Output Capacitance	C _{obo}		31		pF	$V_{CB} = -10V, f = 1MHz^{(*)}$
Delay Time	t _d		21		ns	
Rise Time	t _r		18		ns	I _C = -1A, V _{CC} = -50V,
Storage Time	t _s		680		ns	$I_{B1} = -I_{B2} = -100 \text{mA}$
Fall Time	t _f		75		ns	

Electrical Characteristics (at T_{amb} = 25°C unless otherwise stated)

NOTES:

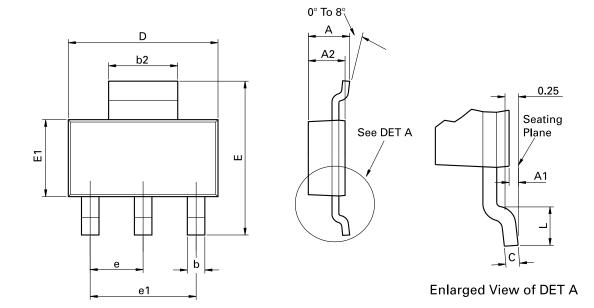
(*) Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%.$

Typical Characteristics



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Package Information – SOT223



Conforms to JEDEC TO-261 AA Issue B

DIM	Millim	neters	Inc	hes	DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	-	1.80	-	0.071	е	2.30 BSC		0.0905 BSC	
A1	0.02	0.10	0.0008	0.004	e1	4.60 BSC		0.181 BSC	
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-
D	6.30	6.70	0.248	0.264	-	-	-	-	-

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